

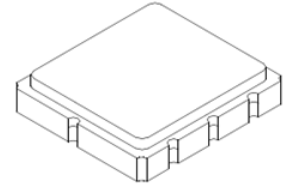
- **No External Matching Required**
- **3.8 x 3.8 x 1.4 mm Surface-mount Package**
- **Complies with Directive 2002/95/EC (RoHS)**
- **Moisture Sensitivity Level: 1**

Absolute Maximum Ratings

Rating	Value	Units
Maximum Incident Power in Passband	+10	dBm
Maximum DC Voltage between any Two Terminals	3	VDC
Storage Temperature Range	-40 to +85	°C
Suitable for Lead-free Soldering - Maximum Soldering Profile	260°C for 30 s	

SF2188D

**340 MHz
SAW Filter**



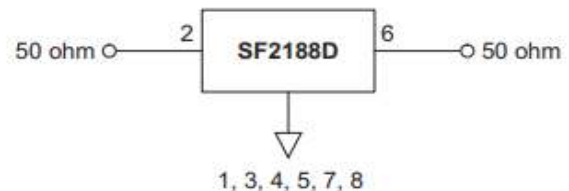
SM3838-8

Electrical Characteristics

Characteristic	Sym	Notes	Min	Typ	Max	Units
Nominal Center Frequency	F_C	1	339	340	341	MHz
Insertion Loss	IL	1		2.0	3.0	dB
1 dB Bandwidth		1		8	11	MHz
Passband Ripple, 336 to 344 MHz		1		0.4	1.0	dB _{P-P}
Absolute Attenuation (referenced from 0 dB)						
10 to 300 MHz		2	50	54		dB
300 to 320 MHz		2	40	47		dB
375 to 800 MHz		2	40	45		dB
Frequency Temperature Coefficient				-36		ppm/°C
Source Impedance				50		ohm
Load Impedance				50		ohm
Operating Temperature Range			-40		+85	°C
Case Style			SM3838-8 3.8 x 3.8 mm Nominal Footprint			
Lid Symbolization (Y=year, WW=week, S=shift)			876, <u>YWWS</u>			

Electrical Connections

Connection	Terminals
Port 1	2
Port 2	6
Case Ground	All others

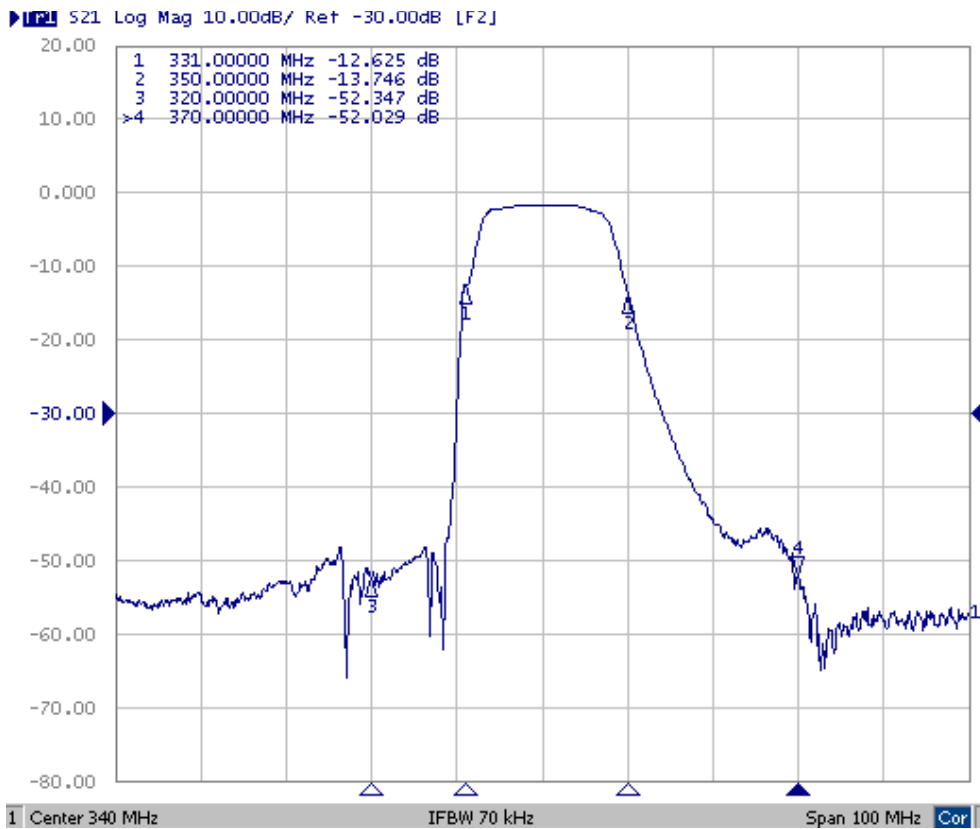
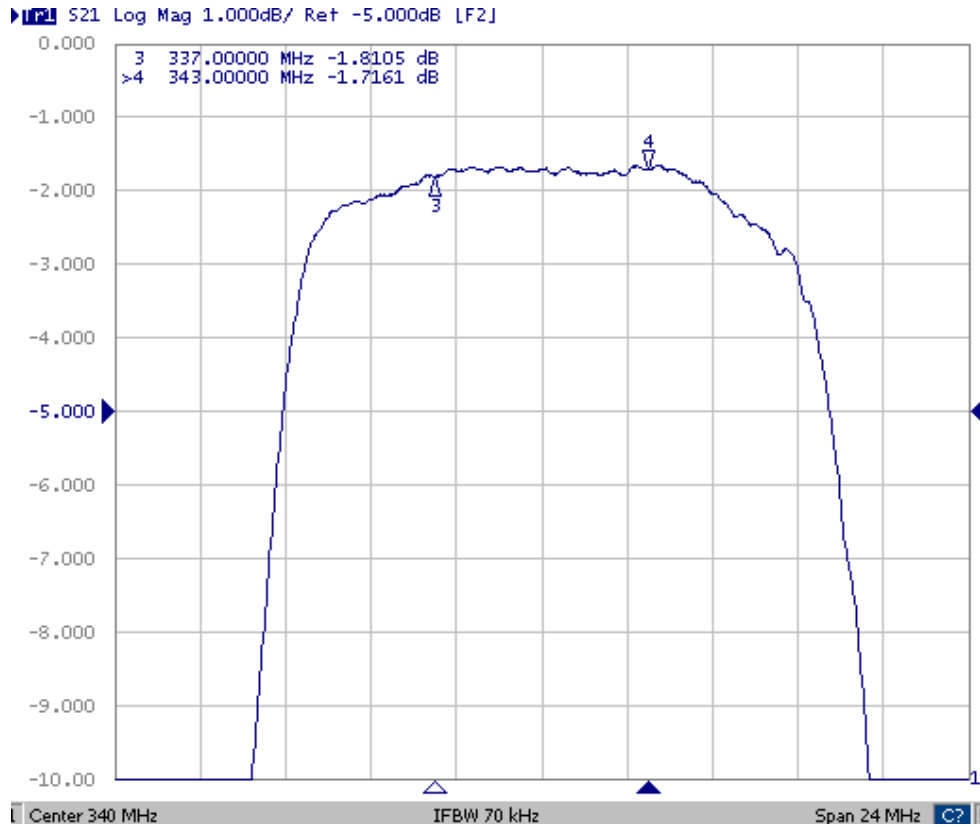


 **CAUTION: Electrostatic Sensitive Device. Observe precautions for handling.**

NOTES:

1. The design, manufacturing process, and specifications of this device are subject to change.
2. US or International patents may apply.
3. RoHS compliant from the first date of manufacture.

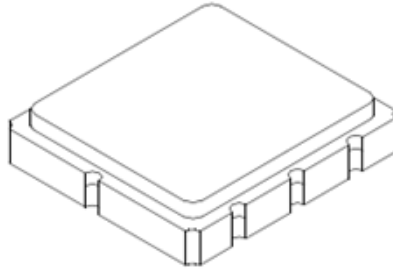
SF2188D Frequency Response



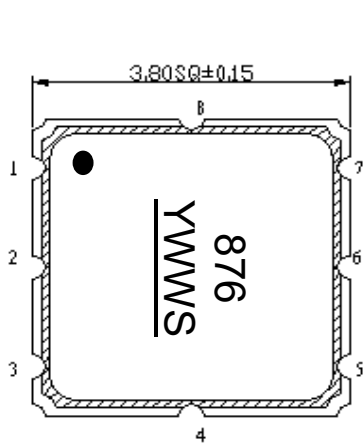
SM3838-8 Case

8-Terminal Ceramic Surface-Mount Case

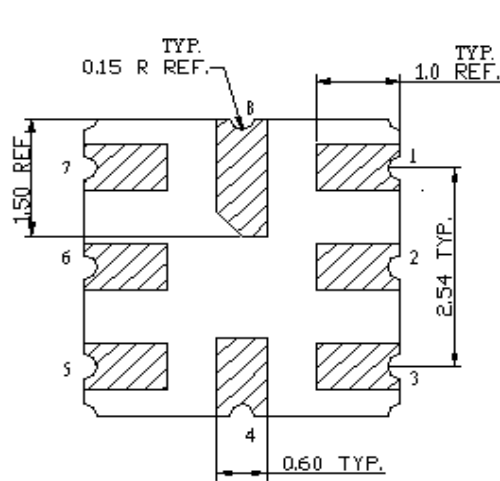
3.8 X 3.8 mm Nominal Footprint



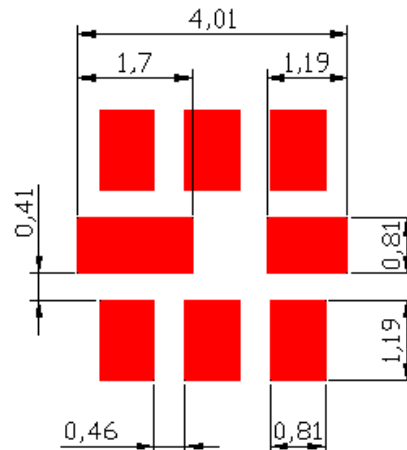
Top View



Bottom View

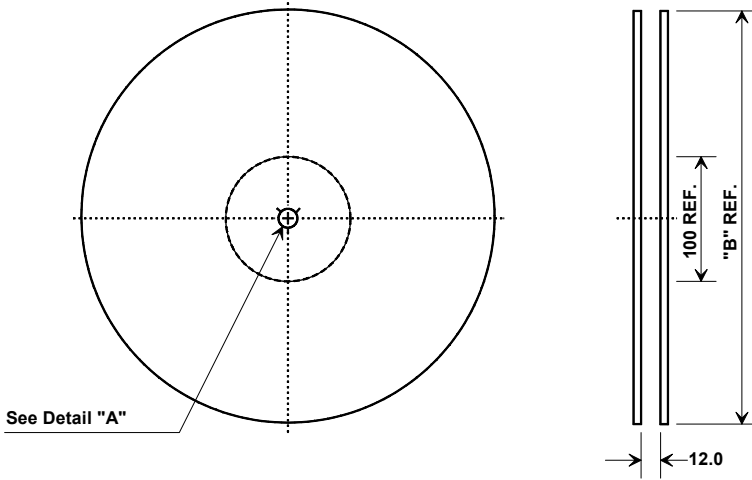


PCB Footprint

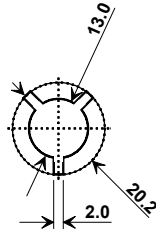


Tape and Reel Specifications

Tape and Reel Standard per ANSI/EIA-481

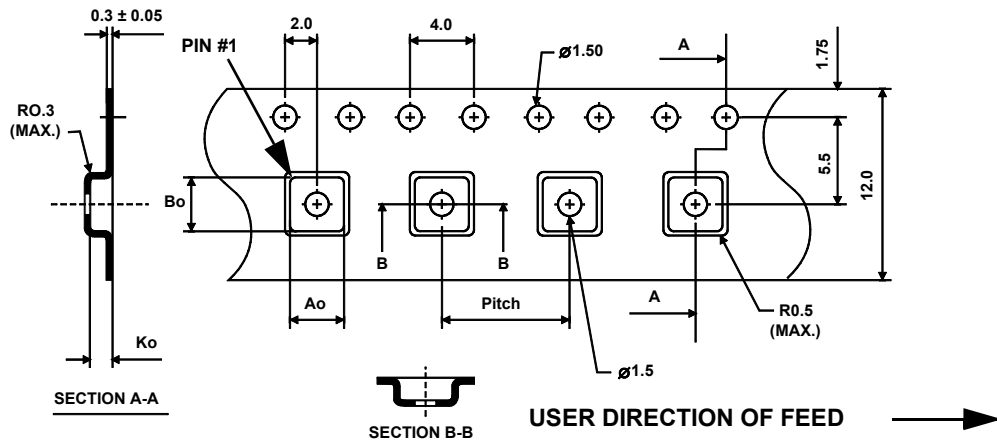


"B "		Quantity Per Reel
Inches	millimeters	
7	178	1000
13	330	3000



COMPONENT ORIENTATION and DIMENSIONS

Carrier Tape Dimensions	
Ao	4.25 mm
Bo	4.25 mm
Ko	1.30 mm
Pitch	8.0 mm
W	12.0 mm



Recommended Reflow Profile

1. Preheating shall be fixed at 150~180°C for 60~90 seconds.
2. Ascending time to preheating temperature 150°C shall be 30 seconds min.
3. Heating shall be fixed at 220°C for 50~80 seconds and at 260°C +0/-5°C peak (10 seconds).
4. Time: 5 times maximum.

